

PATI

05-13-1998

ET

IBM Docket No.: FI9-98-013

ed original documents or copy thereof.

To the Honorable Commissioner of Patents



100709365

1. Name of conveying party(ies):

Birendra N. Agarwala
Hormazdyar M. Dalal
Du B. Nguyen
Hazara S. Rathore

Additional name(s) of conveying party(ies) attached?
[] Yes [X] No

3. Nature of Conveyance:

[X] Assignment [] Merger
[] Security Agreement [] Change of Name
[] Other

Execution Date: 04/16/98; 04/17/98;
04/16/98; 04/16/98

Address of receiving party(ies):

Name: International Business Machines Corporation

Internal Address: N/A

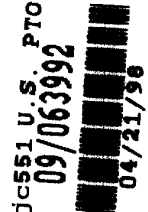
Street Address: Old Orchard Road

City: Armonk State: New York

Zip Code: 10504

Additional Name(s) & Address(es) attached?

[] Yes [X] No



4. Application number(s) or patent number(s):

Title of Application: **METHOD FOR PROVIDING ELECTRICALLY FUSIBLE LINKS IN COPPER INTERCONNECTION**

If this document is being filed together with a new application, the execution date of the application is: 04/16/98; 04/17/98, 19____.
04/16/98; 04/16/98.

A. Patent Application No.(s)
FI9-98-013

B. Patent No.(s)

Additional numbers attached? [] Yes [X] No

5. Name and address of party whom correspondence concerning document should be mailed:

Name: **DeLIO & PETERSON, LLC**
Street Address: **121 Whitney Avenue**
City: **New Haven** State: **CT**
Zip Code: **06510-1241**

6. Total number of applications and patents involved:.....[1]

7. Total Fee (37 CFR 3.41) \$ **\$40.00**
[] Enclosed
[X] Authorized to be charged to Deposit Account number below
[X] Any deficiencies in the enclosed fees

8. Assignee IBM Corporation Deposit Account Number:

09-0458 (FI-203)

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Alison D. Mortinger
Registration No. 39,306

Signature

Date

Total number of pages including cover sheet, attachments, and document: [PATENT]

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4.21.98

ASSIGNMENT

Whereas, we

Inventor and
City(1) **Birendra N. Agarwala**
County of **Dutchess**City of **Hopewell Junction**
and State of **New York**

and

(2) **Hormazdyar M. Dalal**
County of **Ulster**City of **Milton**
and State of **New York**

and

(3) **Du B. Nguyen**
County of **Fairfield**City of **Danbury**
and State of **Connecticut**

and

(4) **Hazara S. Rathore**
County of **Dutchess**City of **Stormville**
and State of **New York**

Title

have invented certain improvements in
**METHOD FOR PROVIDING ELECTRICALLY
FUSIBLE LINKS IN COPPER INTERCONNECTION**Date That
Inventors
Signed the
Declarationand have executed, respectively, a United States patent application therefor on
(1) 4/16/98, 1998, and (2) 4/17/98, 1998,
and (3) 4/16/98, 1998, and (4) 4-16-, 1998.

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

City (1) Signed at East Fishkill NY
City State

Date on 4/16/, 1998 Birendra N. Agarwala signature
Birendra N. Agarwala

ASSIGNMENT (continued)

TITLE: METHOD FOR PROVIDING ELECTRICALLY FUSIBLE LINKS IN COPPER INTERCONNECTION

City (2) Signed at E. Fishkill NY
City State

Date on 4/17/, 1998 Hormaazdyar M. Dalal signature
Hormaazdyar M. Dalal

City (3) Signed at East Fishkill NY
City State

Date on 4/16/, 1998 Du B. Nguyen signature
Du B. Nguyen

City (4) Signed at EAST FISHKILL N. Y.
City State

Date on 4-16-, 1998 Hazará S. Rathore signature
Hazará S. Rathore

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